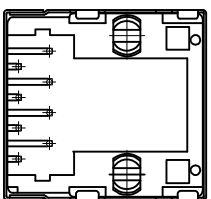


PC Board Layout
Component Side Shown



NOTES:

MATERIAL:

- 1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- 2. CONTACT MATERIAL : PHOSPHOR BRONZE f =0.46mm.
- 3. PLATING : SELECTING GOLD PLATING 3u"~50u" OVER NICKEL
- 4. SHIELD : 0.20mm THICKNESS COPPER ALLOY WITH NICKEL PLATED

ELECTRICAL:

- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
- 5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1. DURABILITY : 750 CYCLES MIN.
 - 2. PCB RETENTION PRE-SOLDER : 1 LB MIN.
- ENVIRONMENTAL:
- 1. STORAGE : -40° C TO 85° C.
 - 2. OPERATION : 0° C TO 70° C.

PART NUMBER:

TOLERANCE TABLE

.0	±0.30
.00	±0.20
.000	±0.05

APPROVED:	DATE:	<p>深圳市灿科盟实业有限公司 Kmtw CHANKLEMENT INDUSTRYCO., LTD</p>	TITLE:	R-J45508P-B000					
CHECKED:	DATE:		RJ45-8P/8C 52E-1 无灯带屏蔽						
DRAWN:	DATE:		UNIT	mm	SCALE	Free	REV.	A	HY04
SXA	2019-04-27		FILE NO.	/					